

STARPOWER

SEMICONDUCTOR

IGBT

GD800HFX170C3S

1700V/800A 2 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as high power converters.

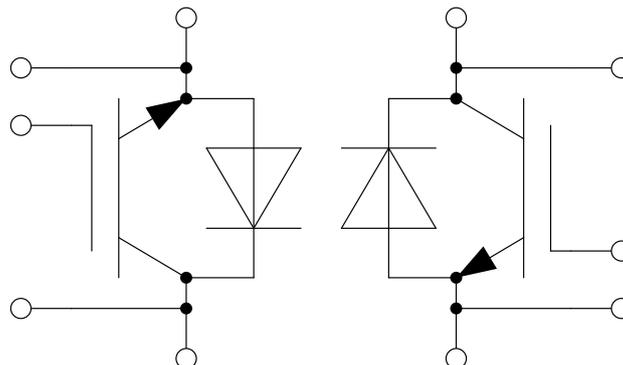
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- High Power Converters
- Motor Drives
- Wind Turbines

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1700	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	1377	A
	@ $T_C=70^{\circ}\text{C}$	800	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	1600	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	4.73	kW

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1700	V
I_F	Diode Continuous Forward Current	800	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	1600	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	4000	V

IGBT Characteristics $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=800\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.85	2.30	V	
		$I_C=800\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.25			
		$I_C=800\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		2.35			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=32.0\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.6	6.2	6.8	V	
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			5.0	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
R_{Gint}	Internal Gate Resistance			1.9		Ω	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		94.6		nF	
C_{res}	Reverse Transfer Capacitance				2.38		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		7.87		μC	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=800\text{A}, R_G=1.2\Omega, V_{GE}=-9/+15\text{V}, L_S=65\text{nH}, T_j=25^\circ\text{C}$		446		ns	
t_r	Rise Time			198		ns	
$t_{d(off)}$	Turn-Off Delay Time			1444		ns	
t_f	Fall Time			193		ns	
E_{on}	Turn-On Switching Loss			202		mJ	
E_{off}	Turn-Off Switching Loss			233		mJ	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC}=900\text{V}, I_C=800\text{A}, R_G=1.2\Omega, V_{GE}=-9/+15\text{V}, L_S=65\text{nH}, T_j=125^\circ\text{C}$		578		ns
t_r	Rise Time				247		ns
$t_{d(off)}$	Turn-Off Delay Time				1780		ns
t_f	Fall Time				352		ns
E_{on}	Turn-On Switching Loss			368		mJ	
E_{off}	Turn-Off Switching Loss			309		mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=800\text{A}, R_G=1.2\Omega, V_{GE}=-9/+15\text{V}, L_S=65\text{nH}, T_j=150^\circ\text{C}$			609		ns
t_r	Rise Time				264		ns
$t_{d(off)}$	Turn-Off Delay Time				1866		ns
t_f	Fall Time				363		ns
E_{on}	Turn-On Switching Loss			413		mJ	
E_{off}	Turn-Off Switching Loss			322		mJ	
I_{SC}	SC Data		$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=1000\text{V}, V_{CEM} \leq 1700\text{V}$		3200		A

Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=800\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.80	2.25	V
		$I_F=800\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.90		
		$I_F=800\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.95		
Q_r	Recovered Charge			111		μC
I_{RM}	Peak Reverse Recovery Current	$V_{CC}=900\text{V}, I_F=800\text{A},$ $-di/dt=3660\text{A}/\mu\text{s}, V_{GE}=-9\text{V},$ $L_S=65\text{nH}, T_j=25^\circ\text{C}$		546		A
E_{rec}	Reverse Recovery Energy			88.9		mJ
Q_r	Recovered Charge			240		μC
I_{RM}	Peak Reverse Recovery Current	$V_{CC}=900\text{V}, I_F=800\text{A},$ $-di/dt=2960\text{A}/\mu\text{s}, V_{GE}=-9\text{V},$ $L_S=65\text{nH}, T_j=125^\circ\text{C}$		635		A
E_{rec}	Reverse Recovery Energy			211		mJ
Q_r	Recovered Charge			264		μC
I_{RM}	Peak Reverse Recovery Current	$V_{CC}=900\text{V}, I_F=800\text{A},$ $-di/dt=2750\text{A}/\mu\text{s}, V_{GE}=-9\text{V},$ $L_S=65\text{nH}, T_j=150^\circ\text{C}$		641		A
E_{rec}	Reverse Recovery Energy			219		mJ

Module Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		20		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.37		m Ω
R_{thJC}	Junction-to-Case (per IGBT)			31.7	K/kW
	Junction-to-Case (per Diode)			53.3	
R_{thCH}	Case-to-Heatsink (per IGBT)		19.1		K/kW
	Case-to-Heatsink (per Diode)		32.2		
	Case-to-Heatsink (per Module)		6.0		
M	Terminal Connection Torque, Screw M4	1.8		2.1	N.m
	Terminal Connection Torque, Screw M8	8.0		10	
	Mounting Torque, Screw M6	4.25		5.75	
G	Weight of Module		1500		g

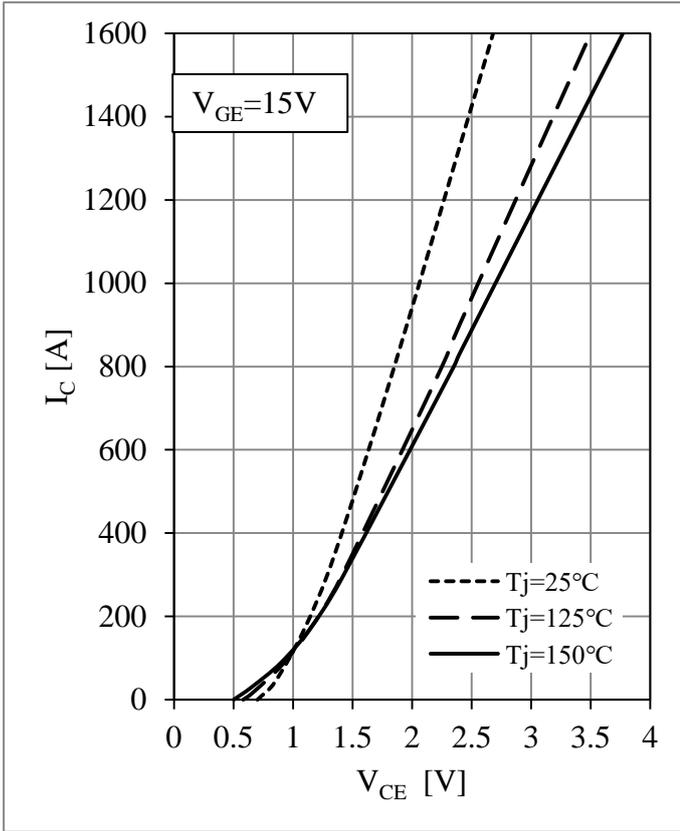


Fig 1. IGBT Output Characteristics

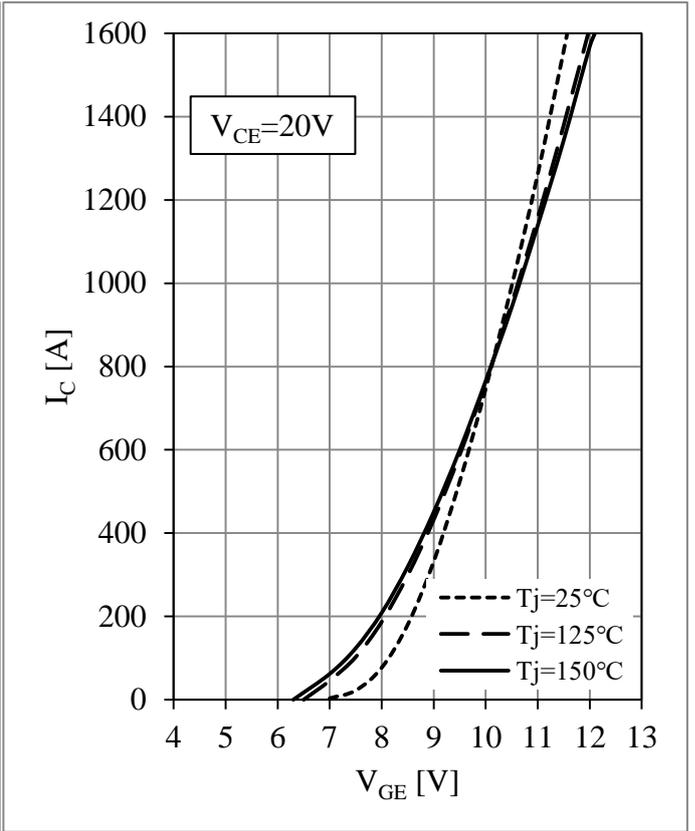


Fig 2. IGBT Transfer Characteristics

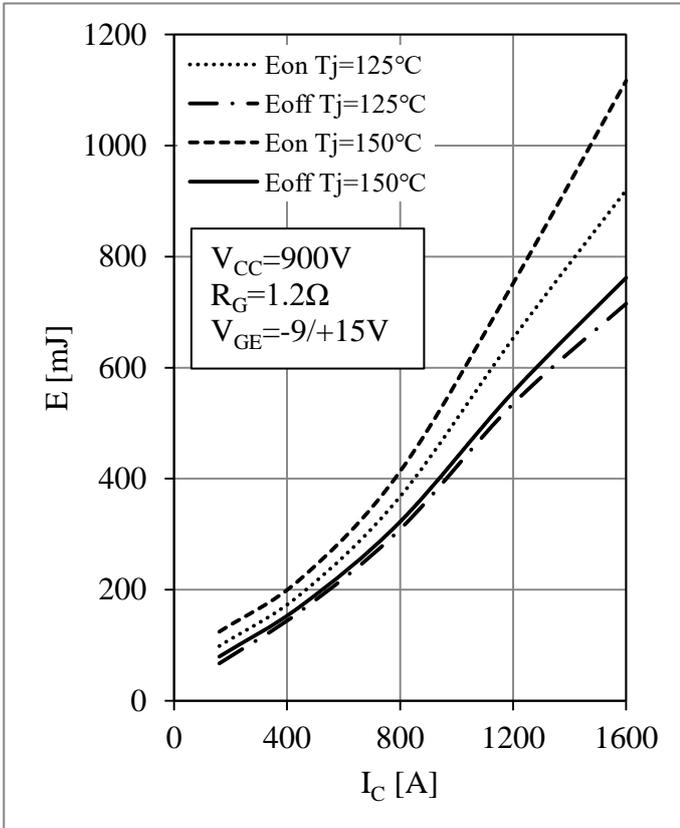


Fig 3. IGBT Switching Loss vs. I_c

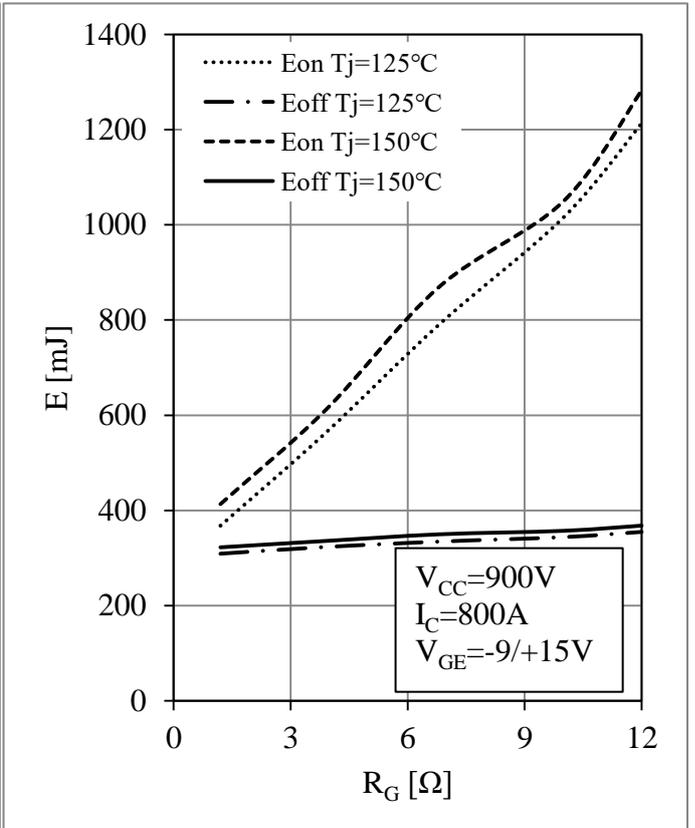


Fig 4. IGBT Switching Loss vs. R_G

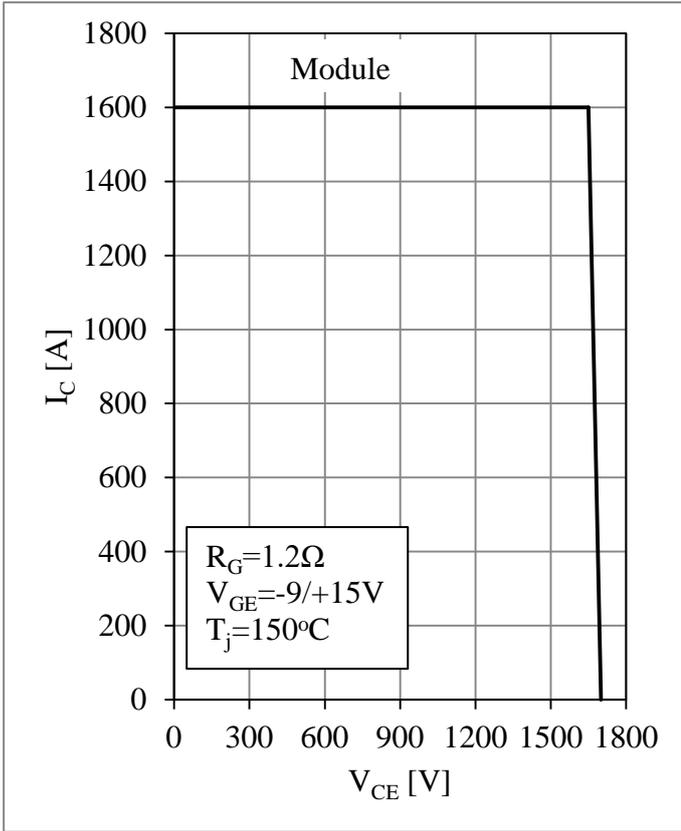


Fig 5. RBSOA

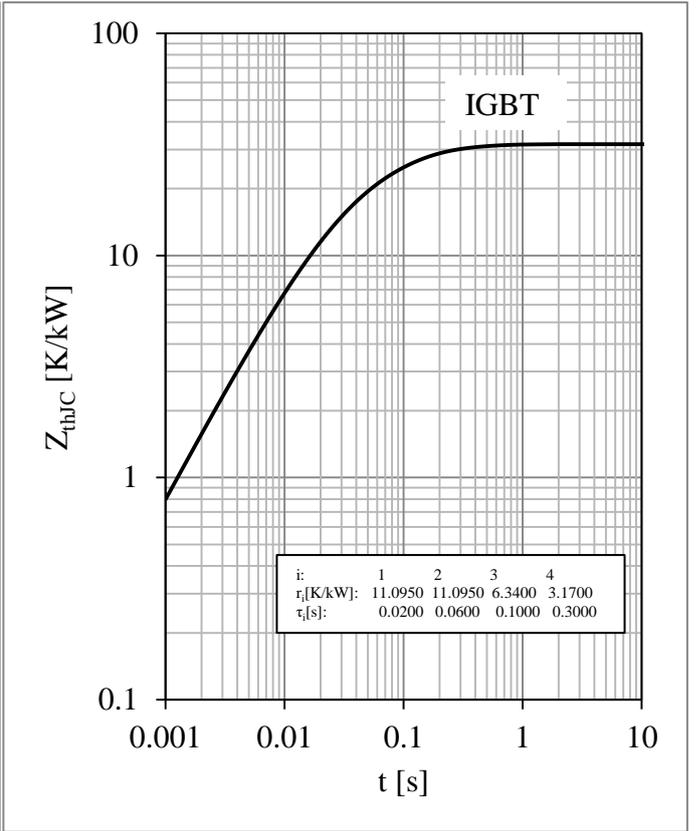


Fig 6. IGBT Transient Thermal Impedance

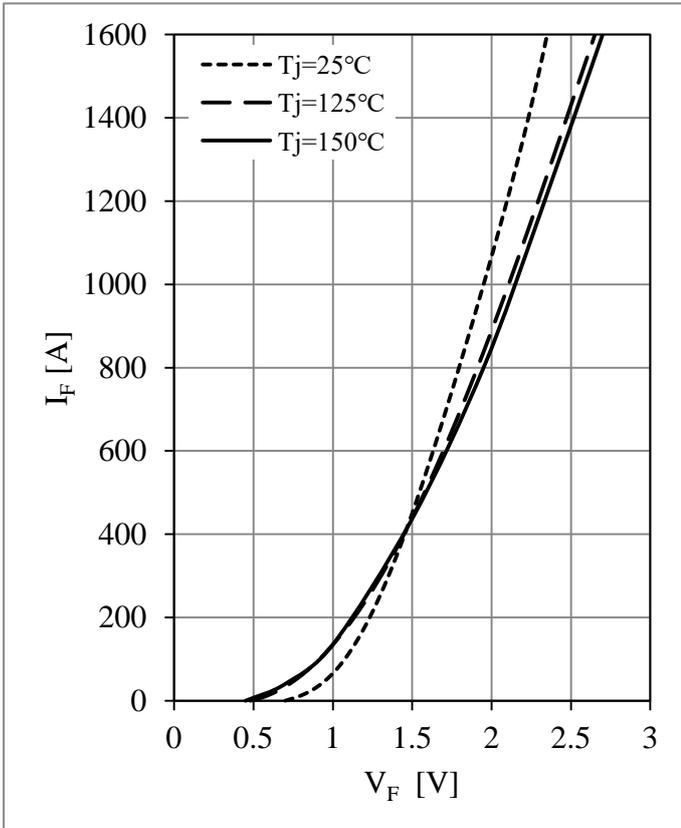


Fig 7. Diode Forward Characteristics

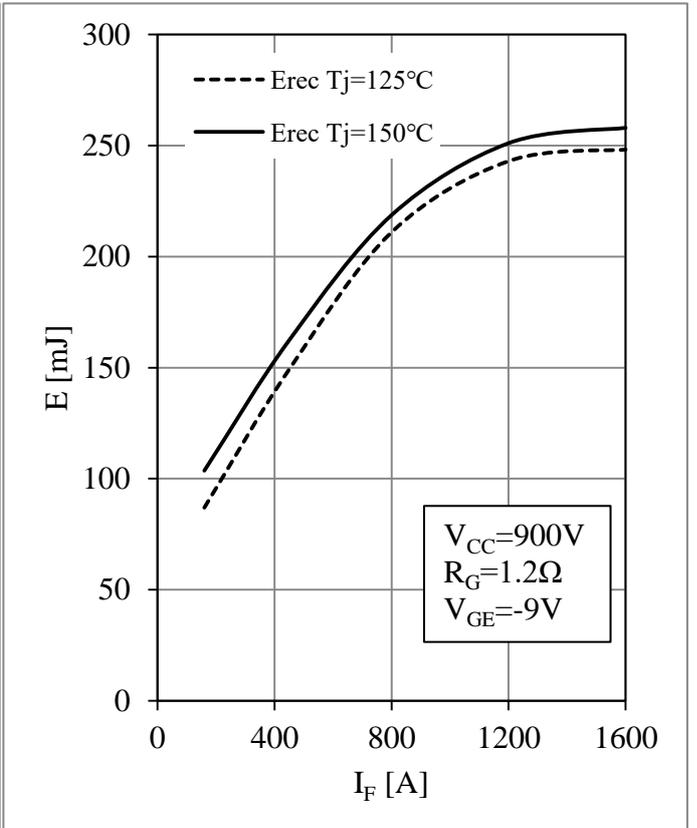


Fig 8. Diode Switching Loss vs. I_F

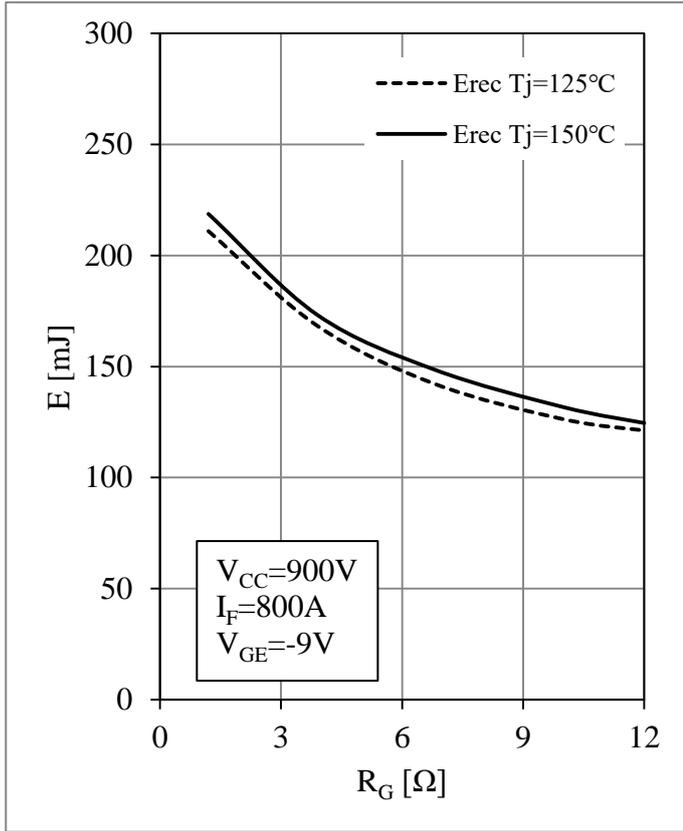


Fig 9. Diode Switching Loss vs. R_G

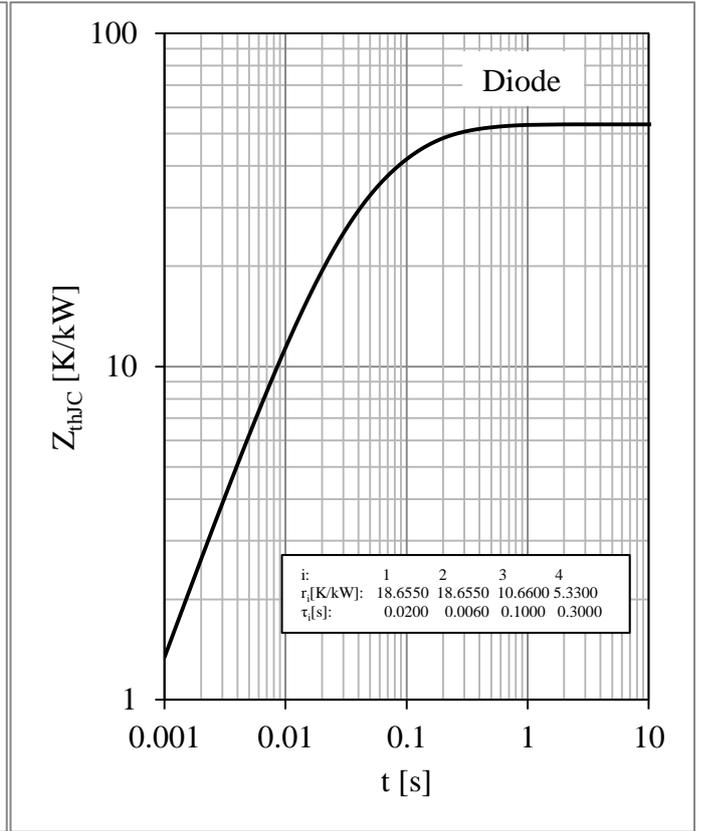


Fig 10. Diode Transient Thermal Impedance

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